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AMENDMENT UNDER 37 CFR 1.116 **EXPEDITED PROCEDURE – EXAMINING GROUP 2813**

Box AF

Assistant Commissioner for Patents

TC 2800 MAIL ROOM

Washington, D.C. 20231

Attorney Docket No.: 018419-008320US

TOWNSEND and TOWNSEND and CREW LLP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kang et al.

Application No.: 09/893,340

Filed: June 26, 2001

For: SURFACE FINISHING OF SOI SUBSTRATES USING AN EPI

PROCESS

Examiner:

Erik J. Kielin

AMENDMENT UNDER 37 CFR 1.116 **EXPEDITED PROCEDURE EXAMINING**

GROUP 2813

Box AF

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Final Office Action mailed September 24, 2002, please amend this application as follows:

IN THE CLAIMS:

Please amend claims 29, 32-34, 36, 37, and 39 as follows.

29. (Amended) A dry method for finishing SOI substrates, said method comprising:

providing an SOI substrate comprising a cleaved surface, said cleaved surface having a first surface roughness value;